

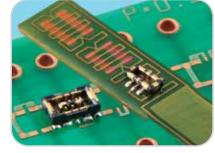
# BM29 Series

# Ultra Compact Hybrid Board to FPC Connectors

#### Features:

- The world smallest FPC connector enables size reduction and flexible design of mobile devices.
- Features hybrid power/signal contacts - Rated current: 3 Amps for power, 0.3 Amps for signal
- Unique metal guides prevent the housing damage due to offset mating.
- Secure mating with clear tactile click
- RoHS compliant, Halogen-free

Pitch: 0.35 mm Depth: 1.5 mm Stacking Height: 0.6 mm

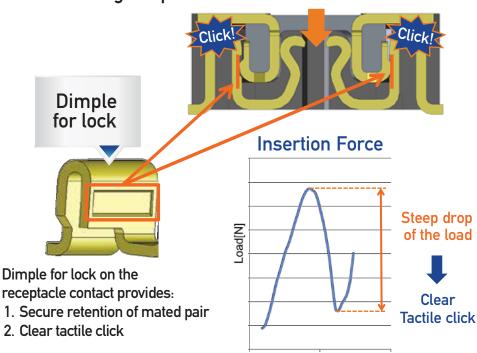




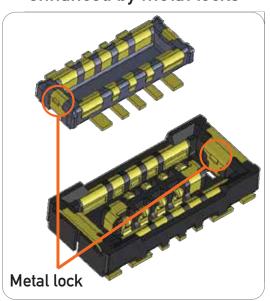
0.35 MM PITCH ULTRA LOW-PROFILE HIGH DENSITY FPC CONNECTOR

## Clear Tactile Click & Positive Lock

Contact design to provide clear tactile mate



Retention force is enhanced by metal locks



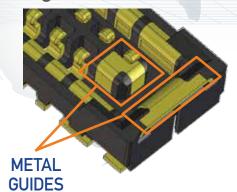


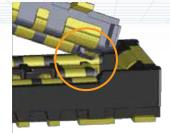
Ultra compact design with stable retention force & clear tactile mating.

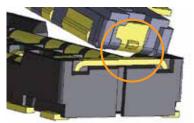
Time

### **Robust Structure**

Metal receptacle guides improves mating robustness.







Prevents housing damage due to offset mating

If the header and the receptacle are mated incorrectly, the metal design prevents the housing from being damaged.

### Part Number System

#### Receptacle

BM 29B 0.6 - \* DS/2 - 0.35 V (51)

0 2 3 45 6

- Series Name: BM
- 2 Series No.: 29B3 Stacking Height
- 4 Signal Contact No. of Pos.: 2
- 5 Connector Type DS: Receptacle
- 6 Power Contact No. of Pos.: 2
- 7 Contact Pitch: 0.35 mm
- 8 Terminal Type V: Straight SMT
- Gold Plating Specification and Packaging Style (51): Gold plating thickness 0.05 μm Tape and reel (20,000 pcs/reel)

#### Header

BM 29B - \* DP/2 - 0.35 V (51)



- 9 4 9
- Series Name: BM
- 2 Series No.: 29B
- 3 Signal Contact No. of Pos.: 2
- Connector Type DP: Header
- 5 Power Contact No. of Pos.: 2
- 6 Contact Pitch: 0.35 mm
- Terminal Type V: Straight SMT
- 8 Gold Plating Specification and Packaging Style
- (51): Gold plating thickness 0.05 µm Tape and reel (20,000 pcs/reel)

## **Specifications**

MATERIAL AND FINISH		
Component	Material	Finish, Remarks
Housing	LCP*1	UL94V-0, Black
Contact	Copper Alloy	Gold plated over Nickel under plating

<sup>\*1:</sup> This product satisfies halogen free requirements defined as 900 ppm maximum chlorine, 900 ppm maximum bromine, and 1500 ppm maximum total of chlorine and bromine.

PERFORMANCE CHARACTERISTICS		
Rated Current	Power Contact: 3 Amps, Signal Contact: 0.3 Amps*2	
Rated Voltage	30 V AC/DC	
Operating Temperature	-40 to +85 °C*2	
Contact Resistance	Power Contact: 30 m $\Omega$ , Signal Contact: 100 m $\Omega$ (Measured at 20 mV AC, 1 kHz, 1 mA)	
Withstanding Voltage	150 V AC for 1 minute	
Insulation Resistance	1000 MΩ MIN. (100 V DC)	
Durability	10 times	



\*2: Includes temperature rise by current flow.

For additional information please go to https://www.hirose.com/product/en/products/BM29/

Specifications herein are subject to change without notice. Contact Hirose for latest specifications, drawings, or availabilities.